

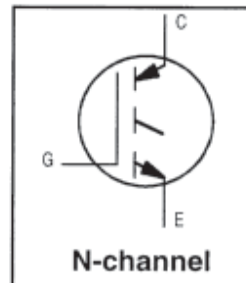
# IRG4RC20FPbF

INSULATED GATE BIPOLAR TRANSISTOR

Fast Speed IGBT

### Features

- Fast: Optimized for medium operating frequencies (1-5 kHz in hard switching, >20 kHz in resonant mode).
- Generation 4 IGBT design provides tighter parameter distribution and higher efficiency than previous generation IGBTs.
- Industry standard TO-252AA package
- Combines very low  $V_{CE(on)}$  with low switching losses
- Lead-Free



|                                   |
|-----------------------------------|
| $V_{CES} = 600V$                  |
| $V_{CE(on)} \text{ typ.} = 1.82V$ |
| @ $V_{GE} = 15V, I_C = 12A$       |

### Benefits

- Generation 4 IGBTs offer highest efficiency
- Optimized for specific application conditions
- High power density and current rating



### Absolute Maximum Ratings

|                           | Parameter   | Max.                               | Units      |
|---------------------------|---|------------------------------------|------------|
| $V_{CES}$                 | Collector-to-Emitter Breakdown Voltage              | 600                                | V          |
| $I_C @ T_C = 25^\circ C$  | Continuous Collector Current                        | 22                                 | A          |
| $I_C @ T_C = 100^\circ C$ | Continuous Collector Current                        | 12                                 |            |
| $I_{CM}$                  | Pulsed Collector Current ①                          | 44                                 |            |
| $I_{LM}$                  | Clamped Inductive Load Current ②                    | 44                                 |            |
| $V_{GE}$                  | Gate-to-Emitter Voltage                             | $\pm 20$                           | V          |
| $E_{ARV}$                 | Reverse Voltage Avalanche Energy ③                  | 5.0                                | mJ         |
| $P_D @ T_C = 25^\circ C$  | Maximum Power Dissipation                           | 66                                 | W          |
| $P_D @ T_C = 100^\circ C$ | Maximum Power Dissipation                           | 26                                 |            |
| $T_J$<br>$T_{STG}$        | Operating Junction and<br>Storage Temperature Range | -55 to + 150                       | $^\circ C$ |
|                           | Soldering Temperature, for 10 seconds               | 300 (0.063 in. (1.6mm) from case ) |            |
|                           | Mounting torque, 6-32 or M3 screw.                  | 10 lbf•in (1.1N•m)                 |            |

### Thermal Resistance

|                 | Parameter                        | Typ.       | Max. | Units        |
|-----------------|----------------------------------|------------|------|--------------|
| $R_{\theta JC}$ | Junction-to-Case                 | —          | 1.9  | $^\circ C/W$ |
| $R_{\theta JA}$ | Junction-to-Ambient (PCB mount)* | —          | 50   |              |
| Wt              | Weight                           | 0.3 (0.01) | —    | g (oz)       |

\* When mounted on 1" square PCB (FR-4 or G-10 Material).

For recommended footprint and soldering techniques refer to application note #AN-994

## Electrical Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

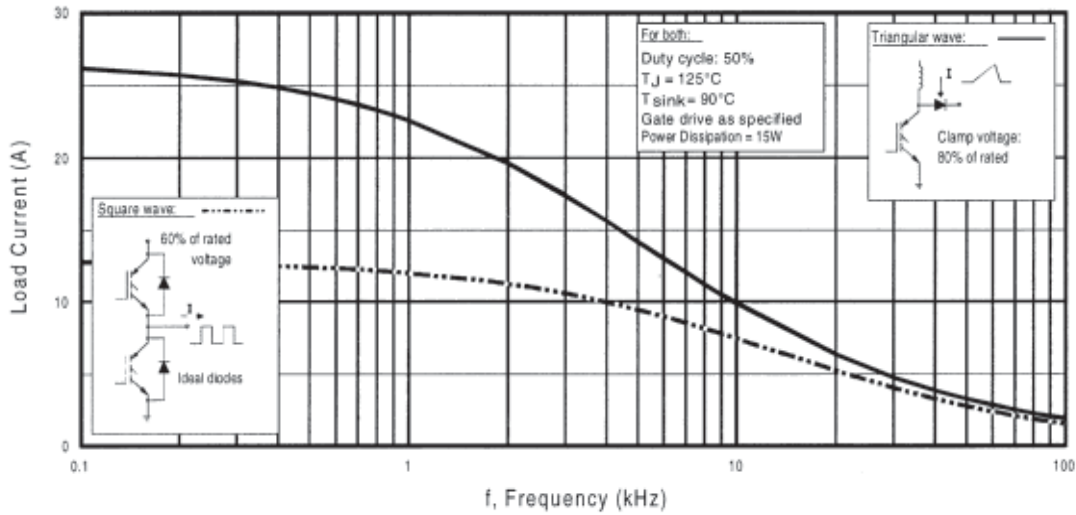
|                                 | Parameter                                | Min. | Typ. | Max.      | Units   | Conditions  |
|---------------------------------|--|------|------|-----------|---------|---|
| $V_{(BR)CES}$                   | Collector-to-Emitter Breakdown Voltage   | 600  | —    | —         | V       | $V_{GE} = 0V, I_C = 250\mu A$                         |
| $V_{(BR)ECS}$                   | Emitter-to-Collector Breakdown Voltage ④ | 18   | —    | —         | V       | $V_{GE} = 0V, I_C = 1.0A$                             |
| $\Delta V_{(BR)CES}/\Delta T_J$ | Temperature Coeff. of Breakdown Voltage  | —    | 0.72 | —         | V/°C    | $V_{GE} = 0V, I_C = 1.0mA$                            |
| $V_{CE(ON)}$                    | Collector-to-Emitter Saturation Voltage  | —    | 1.82 | 2.1       | V       | $I_C = 12A$<br>$V_{GE} = 15V$<br>See Fig.2, 5         |
|                                 |  | —    | 2.42 | —         |         |   |
|                                 |  | —    | 2.04 | —         |         |   |
| $V_{GE(th)}$                    | Gate Threshold Voltage                   | 3.0  | —    | 6.0       |         | $V_{CE} = V_{GE}, I_C = 250\mu A$                     |
| $\Delta V_{GE(th)}/\Delta T_J$  | Temperature Coeff. of Threshold Voltage  | —    | -11  | —         | mV/°C   | $V_{CE} = V_{GE}, I_C = 250\mu A$                     |
| $g_{fe}$                        | Forward Transconductance ⑤               | 5.2  | 7.75 | —         | S       | $V_{CE} = 100V, I_C = 12A$                            |
| $I_{CES}$                       | Zero Gate Voltage Collector Current      | —    | —    | 250       | $\mu A$ | $V_{GE} = 0V, V_{CE} = 600V$                          |
|                                 |  | —    | —    | 2.0       |         | $V_{GE} = 0V, V_{CE} = 10V, T_J = 25^\circ\text{C}$   |
|                                 |  | —    | —    | 1000      |         | $V_{GE} = 0V, V_{CE} = 600V, T_J = 150^\circ\text{C}$ |
| $I_{CES}$                       | Gate-to-Emitter Leakage Current          | —    | —    | $\pm 100$ | nA      | $V_{GE} = \pm 20V$                                    |

## Switching Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

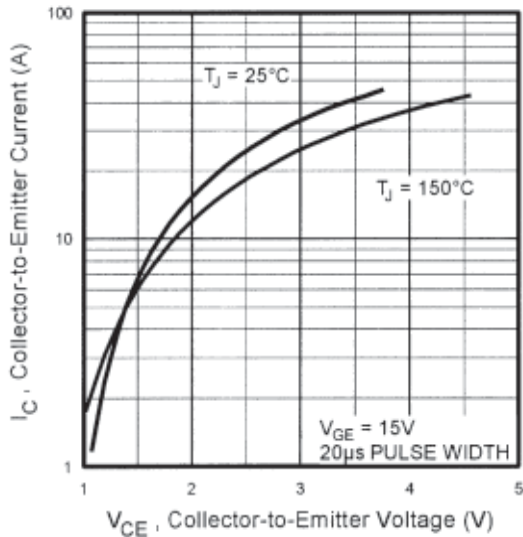
|              | Parameter                         | Min. | Typ. | Max. | Units | Conditions   |
|--------------|-----------------------------------|------|------|------|-------|--|
| $Q_g$        | Total Gate Charge (turn-on)       | —    | 27   | 40   | nC    | $I_C = 12A$<br>$V_{CC} = 400V$<br>$V_{GE} = 15V$<br>See Fig. 8   |
| $Q_{ge}$     | Gate - Emitter Charge (turn-on)   | —    | 4.8  | 6.8  |       |  |
| $Q_{gc}$     | Gate - Collector Charge (turn-on) | —    | 11.4 | 17   |       |  |
| $t_{d(on)}$  | Turn-On Delay Time                | —    | 26   | —    | ns    | $T_J = 25^\circ\text{C}$<br>$I_C = 12A, V_{CC} = 480V$<br>$V_{GE} = 15V, R_G = 50\Omega$<br>Energy losses include "tail"<br>See Fig. 9, 10, 14 |
| $t_r$        | Rise Time                         | —    | 24   | —    |       |  |
| $t_{d(off)}$ | Turn-Off Delay Time               | —    | 194  | 290  |       |  |
| $t_f$        | Fall Time                         | —    | 226  | 340  |       |  |
| $E_{on}$     | Turn-On Switching Loss            | —    | 0.19 | —    |       |  |
| $E_{off}$    | Turn-Off Switching Loss           | —    | 0.92 | —    | mJ    | See Fig. 11, 14  |
| $E_{ts}$     | Total Switching Loss              | —    | 1.11 | 1.4  |       |  |
| $t_{d(on)}$  | Turn-On Delay Time                | —    | 25   | —    | ns    | $T_J = 150^\circ\text{C}$ ,<br>$I_C = 12A, V_{CC} = 480V$<br>$V_{GE} = 15V, R_G = 50\Omega$<br>Energy losses include "tail"<br>See Fig. 11, 14 |
| $t_r$        | Rise Time                         | —    | 26   | —    |       |  |
| $t_{d(off)}$ | Turn-Off Delay Time               | —    | 263  | —    |       |  |
| $t_f$        | Fall Time                         | —    | 443  | —    |       |  |
| $E_{ts}$     | Total Switching Loss              | —    | 1.89 | —    | mJ    | See Fig. 11, 14  |
| $L_E$        | Internal Emitter Inductance       | —    | 7.5  | —    | nH    | Measured 5mm from package  |
| $C_{ies}$    | Input Capacitance                 | —    | 540  | —    | pF    | $V_{GE} = 0V$<br>$V_{CC} = 30V$<br>$f = 1.0MHz$<br>See Fig. 7  |
| $C_{oes}$    | Output Capacitance                | —    | 37   | —    |       |  |
| $C_{res}$    | Reverse Transfer Capacitance      | —    | 7.0  | —    |       |  |

### Notes:

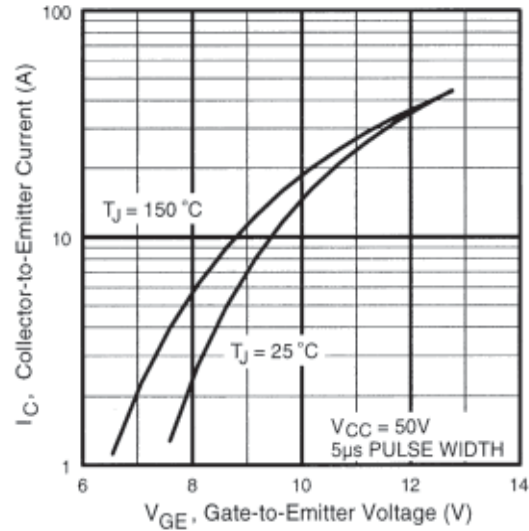
- ① Repetitive rating;  $V_{GE} = 20V$ , pulse width limited by max. junction temperature. ( See fig. 13b )
- ②  $V_{CC} = 80\%(V_{CES})$ ,  $V_{GE} = 20V$ ,  $L = 10\mu H$ ,  $R_G = 50\Omega$ , (See fig. 13a)
- ③ Repetitive rating; pulse width limited by maximum junction temperature.
- ④ Pulse width  $\leq 80\mu s$ ; duty factor  $\leq 0.1\%$ .
- ⑤ Pulse width  $5.0\mu s$ , single shot.



**Fig. 1 - Typical Load Current vs. Frequency**  
 (Load Current =  $I_{\text{RMS}}$  of fundamental)



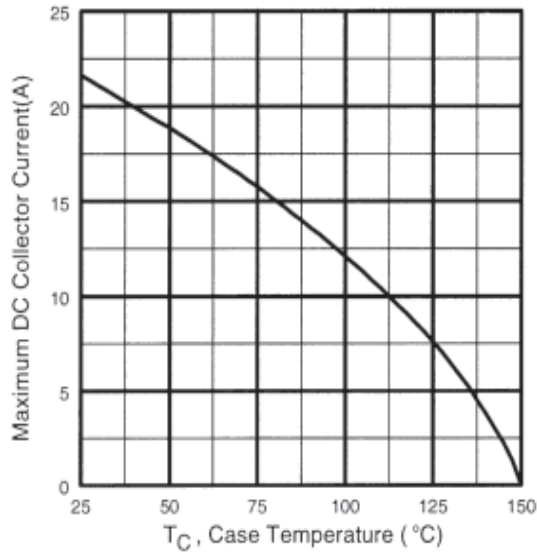
**Fig. 2 - Typical Output Characteristics**



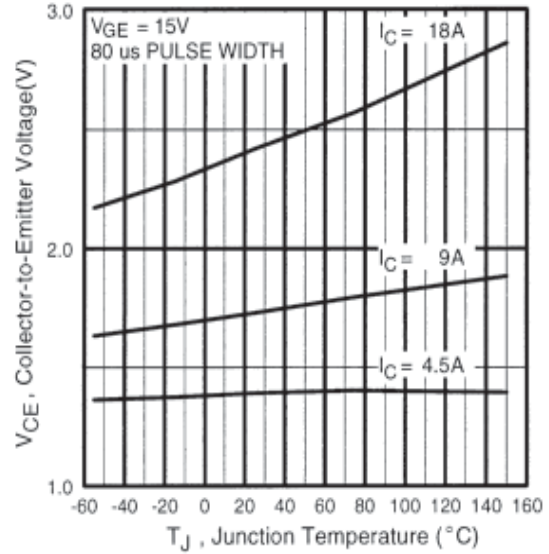
**Fig. 3 - Typical Transfer Characteristics**

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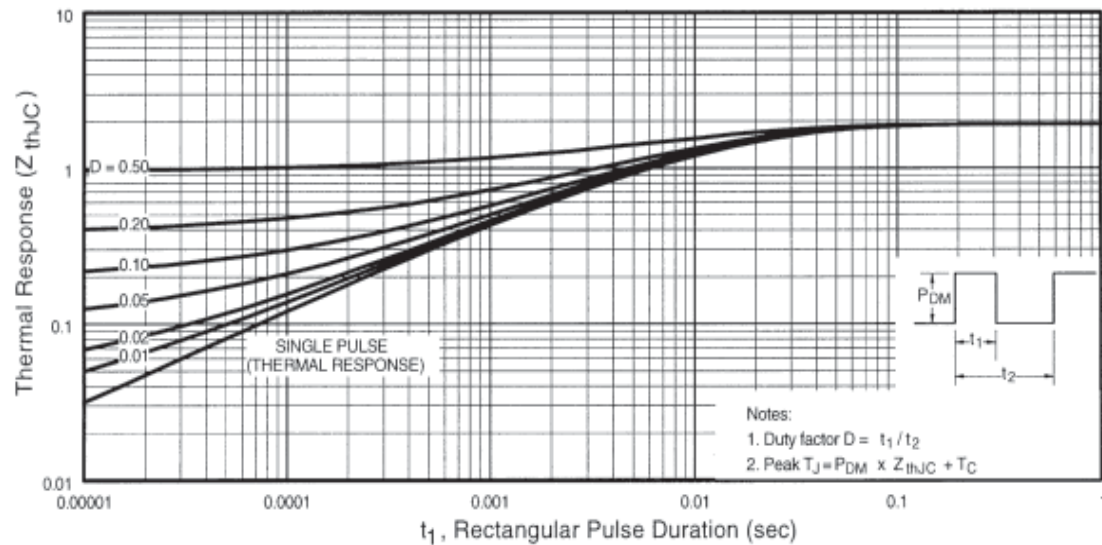
International  
**IR** Rectifier



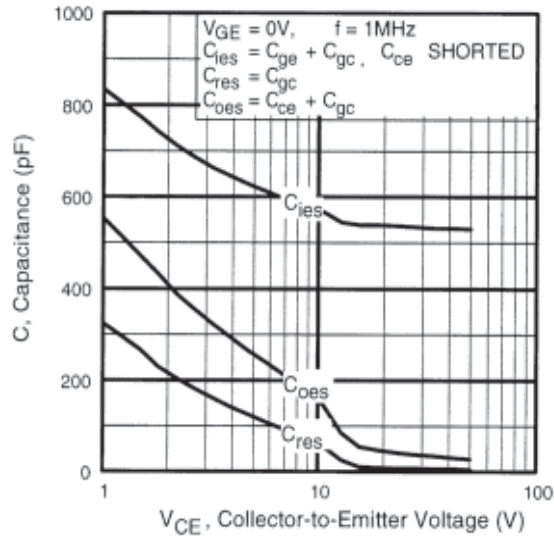
**Fig. 4** - Maximum Collector Current vs. Case Temperature



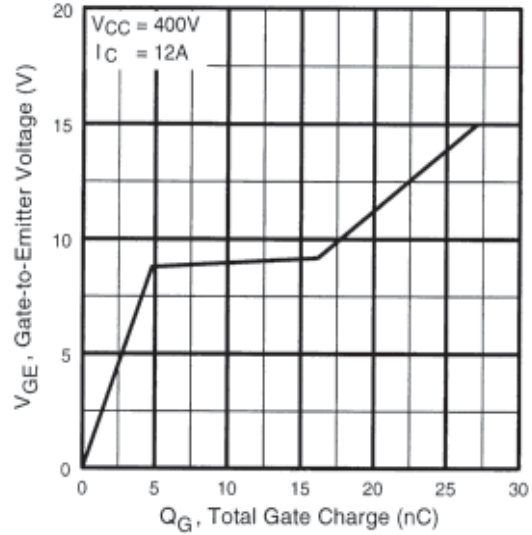
**Fig. 5** - Typical Collector-to-Emitter Voltage vs. Junction Temperature



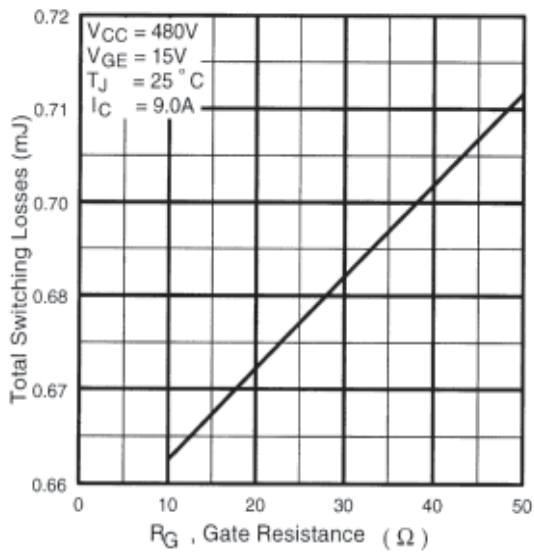
**Fig. 6** - Maximum Effective Transient Thermal Impedance, Junction-to-Case



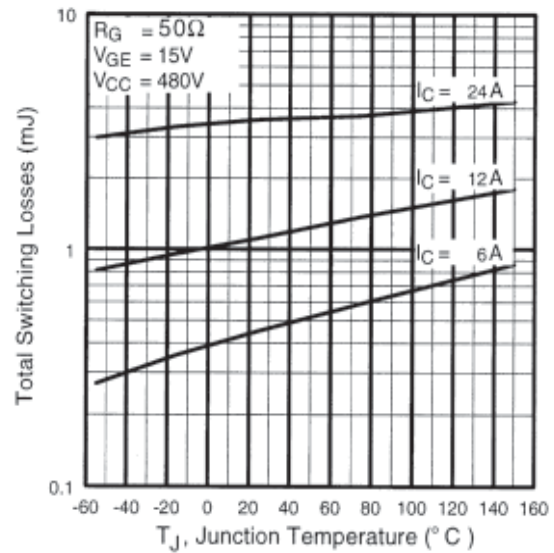
**Fig. 7** - Typical Capacitance vs. Collector-to-Emitter Voltage



**Fig. 8** - Typical Gate Charge vs. Gate-to-Emitter Voltage



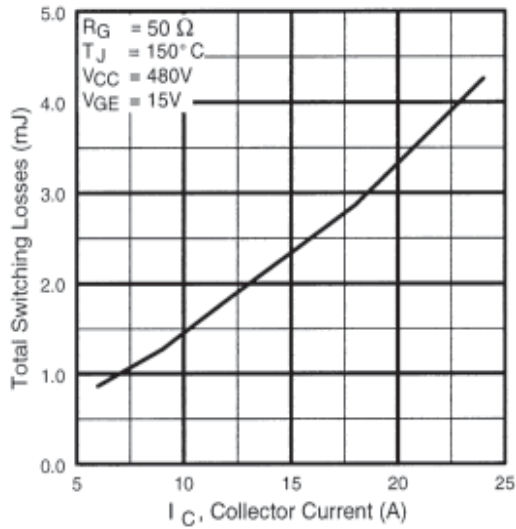
**Fig. 9** - Typical Switching Losses vs. Gate Resistance



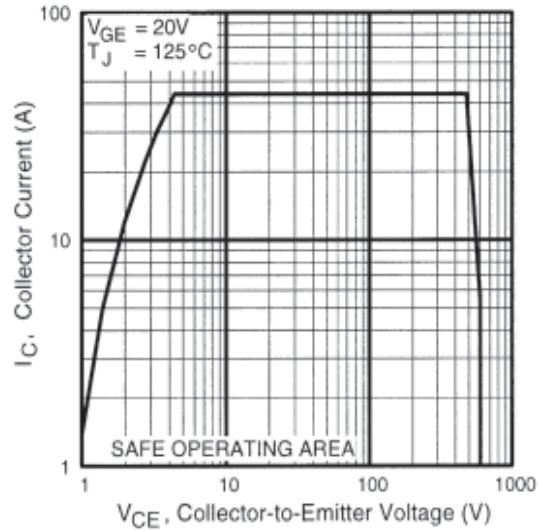
**Fig. 10** - Typical Switching Losses vs. Junction Temperature

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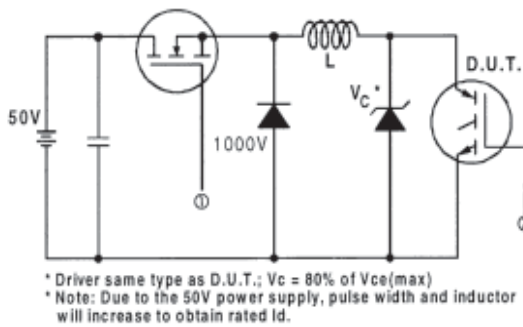
International  
**IR** Rectifier



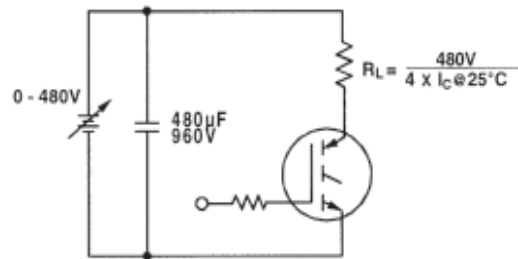
**Fig. 11** - Typical Switching Losses vs. Collector-to-Emitter Current



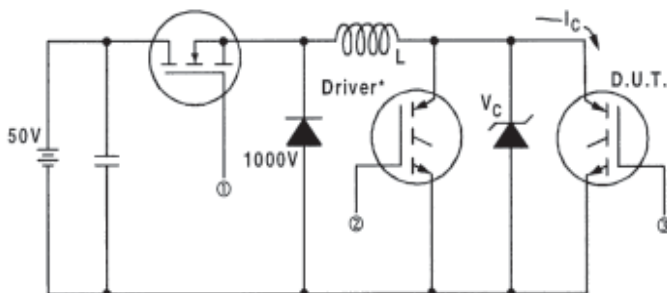
**Fig. 12** - Turn-Off SOA



**Fig. 13a** - Clamped Inductive Load Test Circuit



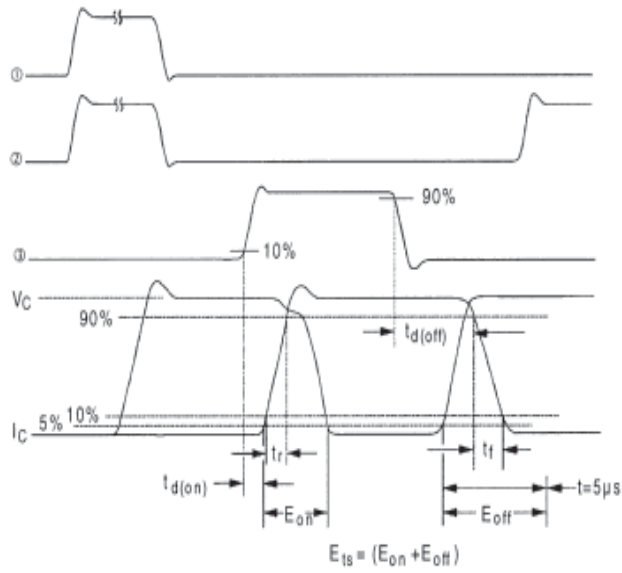
**Fig. 13b** - Pulsed Collector Current Test Circuit



**Fig. 14a** - Switching Loss Test Circuit

\* Driver same type as D.U.T.,  $V_C = 480\text{V}$





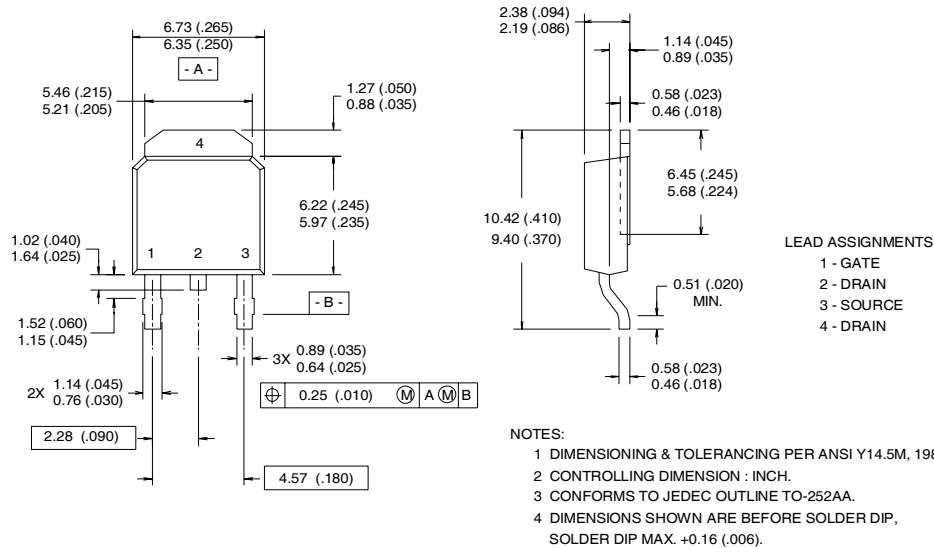
**Fig. 14b** - Switching Loss Waveforms

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International  
**IR** Rectifier

## D-Pak (TO-252AA) Package Outline

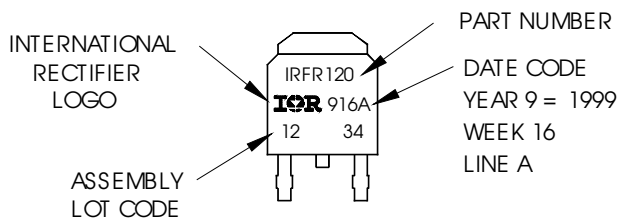
Dimensions are shown in millimeters (inches)



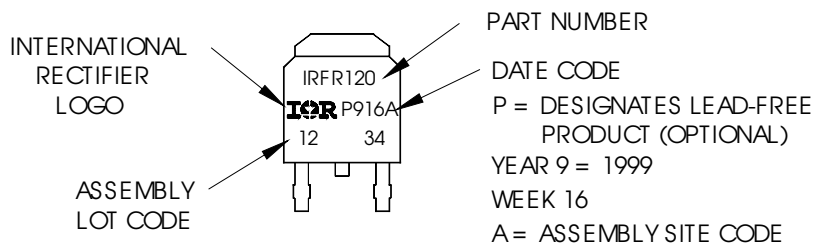
## D-Pak (TO-252AA) Part Marking Information

EXAMPLE: THIS IS AN IRFR120  
WITH ASSEMBLY  
LOT CODE 1234  
ASSEMBLED ON WW 16, 1999  
IN THE ASSEMBLY LINE "A"

Note: "P" in assembly line position indicates "Lead-Free"



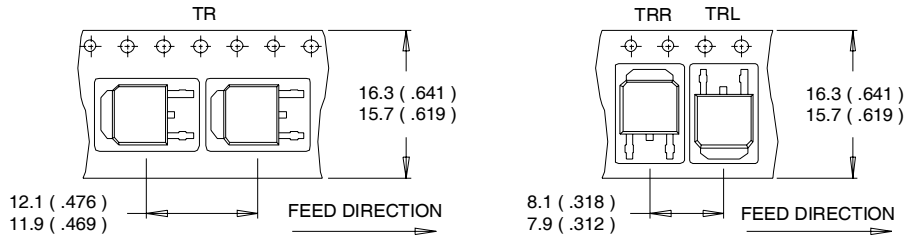
**OR**





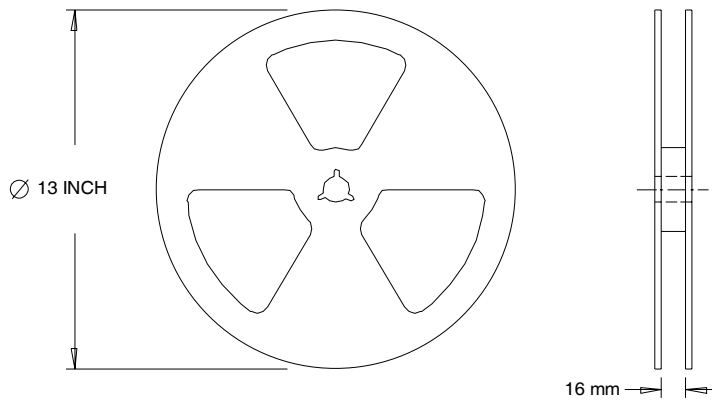
## D-Pak (TO-252AA) Tape & Reel Information

Dimensions are shown in millimeters (inches)



**NOTES :**

1. CONTROLLING DIMENSION : MILLIMETER.
2. ALL DIMENSIONS ARE SHOWN IN MILLIMETERS ( INCHES ).
3. OUTLINE CONFORMS TO EIA-481 & EIA-541.



**NOTES :**

1. OUTLINE CONFORMS TO EIA-481.

Data and specifications subject to change without notice.  
 This product has been designed and qualified for the industrial market.  
 Qualification Standards can be found on IR's Web site.

Note: For the most current drawings please refer to the IR website at:  
<http://www.irf.com/package/>